

Electronic Patent Application Fee Transmittal

Application Number:	10522840			
Filing Date:	27-Jan-2005			
Title of Invention:	Method and apparatus for injection foaming molding			
First Named Inventor/Applicant Name:	Tatsuya Tanaka			
Filer:	Marvin Jay Spivak/Shawn Berry			
Attorney Docket Number:	265044US0PCT			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1615	2	50	100
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	1252	1	460	460
Miscellaneous:				
Total in USD (\$)				560